



PCB LAYOUT MOUNTING PATTERN  
TOP VIEW

**Material:**

- 1.Housing: LCP,UL 94V-0 LCP, Black
- 2.Contact: Phosphor Bronze
- 3.Shell: SUS
- 4.Cover: PA10T,UL 94V-0 LCP, Black

**Finish:**

- 1.Contact: Plated Gold in Mating Area ;  
Gold Plated on Solder Balls  
Nickel under plated overall
- 2.Shell: Nickel under Plated surface layer

3	新增PCB LAYOUT的PIN長尺寸	Jack	102115
2	更新材質	Jack	072215
1	更新圖面	Jack	071615
ITEM NO.	DESCRIPTION	DRAWN	DATE

東莞市高迪電子有限公司  
DONG GUAN GAO DI ELECTRONICS CO., LTD

TOLERANCE UNLESS OTHERWISE STATED:  
Up to 5 ±0.2  
Above 5 ~ 15 ±0.3  
Above 15 ~ 30 ±0.4  
Above 30 ~ 50 ±0.5  
Angle ±0.3

3RD. ANGEL'S

UNITS MM

DRAWN BY:	DATE	MAT'L	TITLE	CONNECTOR
Jack Lu	10/21/15			
CHECKED BY:	DATE	FINISH	MODLE	MICRO USB 防水型
Jacky Chen	10/21/15			
APPROVED BY:	DATE	SCALE	DWG NO.	MRUSB-5B-WP1-S052
Tony Kao	10/21/15	1 : 1	PART NO.	MRUSB-5B-WP1-S052
		SHEET NO.	1 of 1	SIZE A4
				VER R3